

Features

- K1 IR VCSEL
- ROHS and REACH Compliant
- ESD(HBM) 8KV
- MSL 3 Qualified (J-STD 020)

Applications

- Industrial facility applications
- Consumer Mobile
- Automotive Interior & Exterior
- 3D Sensing(TOF, Structure Light)
- Bio recognition

Description

The INV-K1TOIR is a high-power IR VCSEL. It is a SMD type package which can be used in various applications.



Recommended Solder Pattern (Suggest Stencil t=0.12 mm)

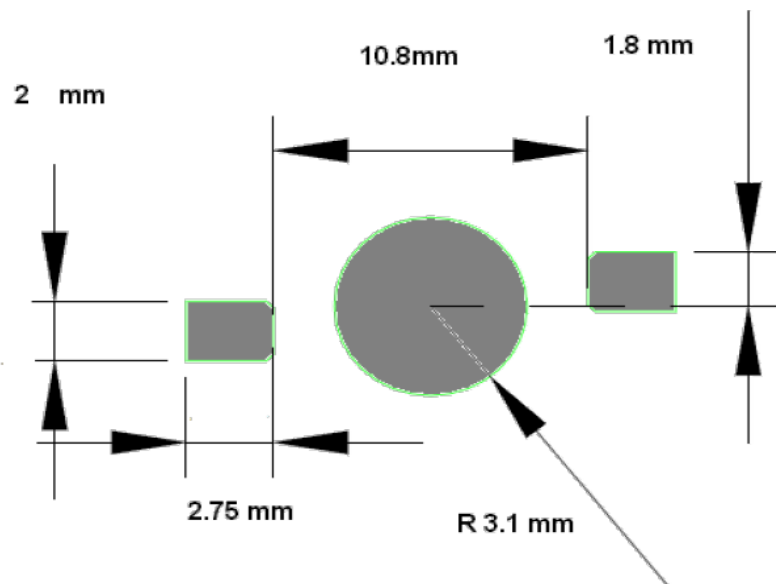


Figure 1. INV-K1TOIR Recommended Solder Pattern

Note:

- *All dimensions are in millimeters.
- *Tolerance is $\pm 0.1\text{mm}$ unless other specified.

Package Dimensions in mm

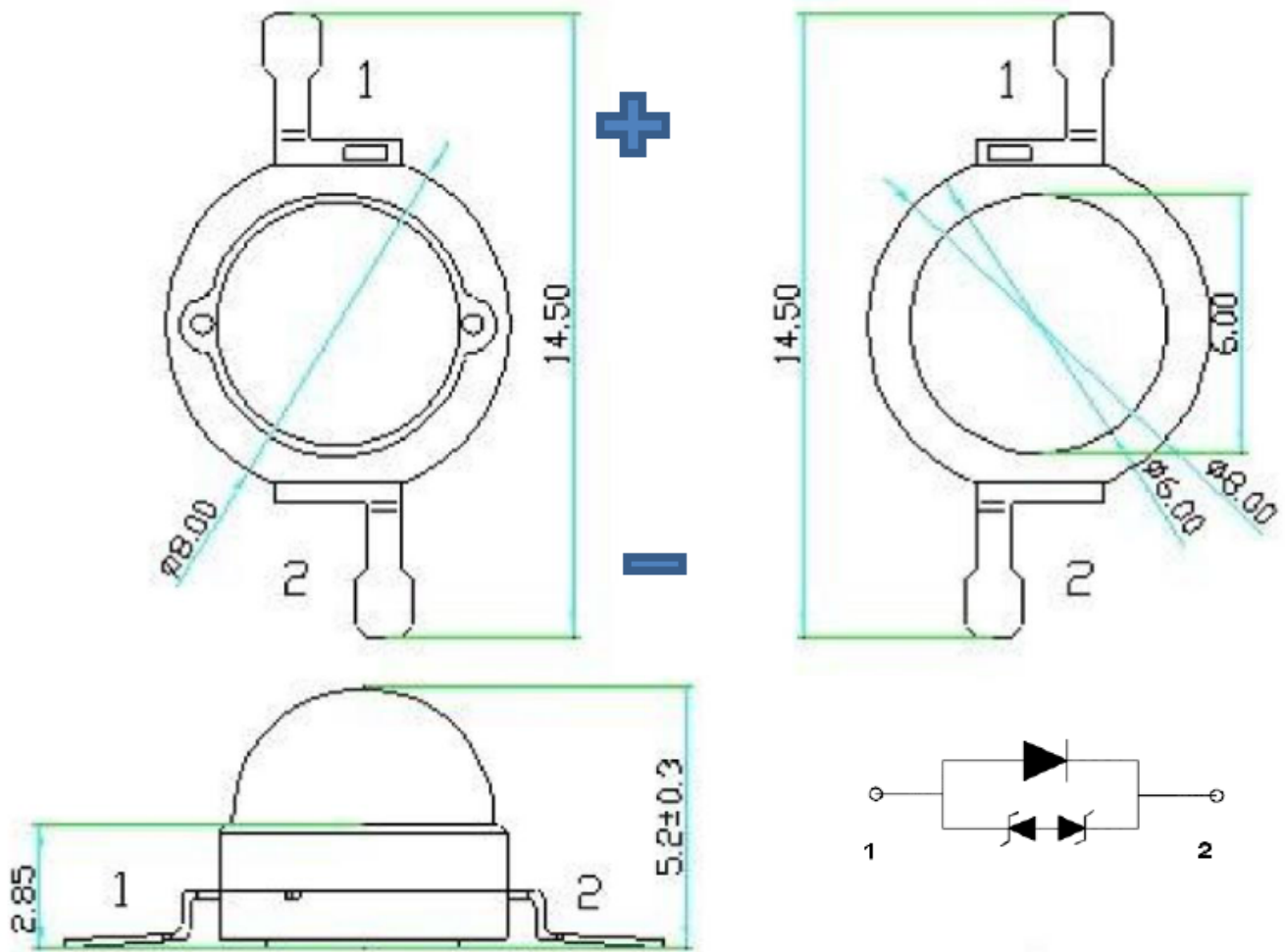


Figure 2. INV-K1TOIR Package Dimensions

***Note**

All dimensions are in millimeters. Tolerance is $\pm 0.1\text{mm}$ unless other specified.

Absolute Maximum Rating at 25°C (Note 1)

Product	Pulse Current(mA) (@1/10 duty)	V _R (V) Typ.	K (mV/°C) Temperature coefficient of voltage	Max. T _j (°C) LED junction temperature	Typ. R _{js} (°C/W) Thermal resistance, junction to solder point.	Typ. ESD (V) Electrostatic discharge threshold
INV-K1TOIR	1600	5	-1.2	110	18	8000

Notes

1. For other ambient, limited setting of current will depend on de-rating curves.
2. When drive on maximum current , T_j must be kept below 110°C
3. Viewing angle(2θ 1/2) ± 10°

Electrical Characteristics T_A = 25°C (Note 1)

Product	V _F (V)@1200mA		Radiometric Power (mW) @1200mA			Peak Wavelength (nm) @1200mA			IR (μA) (V _R =5V)	View Angle
	min	max	min	typ	max	min	typ	max	Max	2θ1/2
INV-K1TOIR	1.8	2.8	700	---	1100	840	---	860	10	30

*Notes

1. Performance guaranteed only under conditions listed in above tables.
2. Viewing angle(2θ1/2) ± 10°

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

Binning Definition (Binning@1200mA)**Power Bin**

Bin Code	Min.	Max.	Unit
P70	700	800	mW
P80	800	900	
P90	900	1000	
P100	1000	1100	

Wavelength Bin

Bin Code	Min.	Max.	Unit
W84	840	860	nm

Voltage Bin

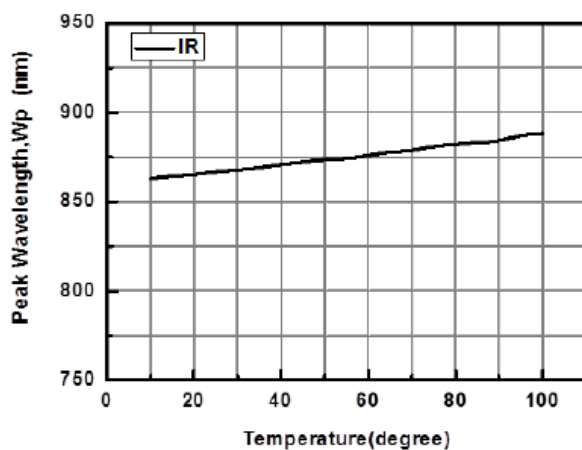
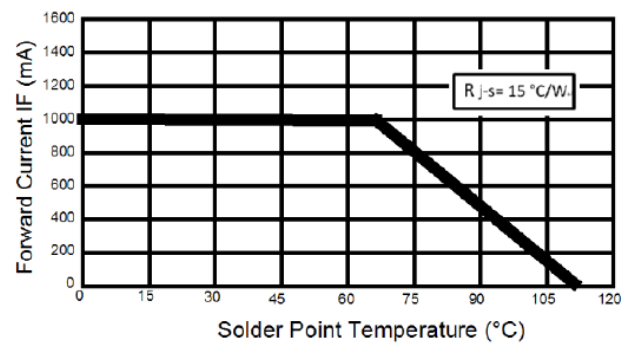
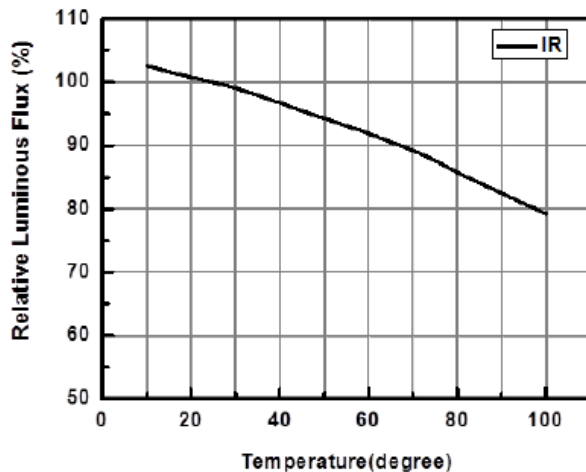
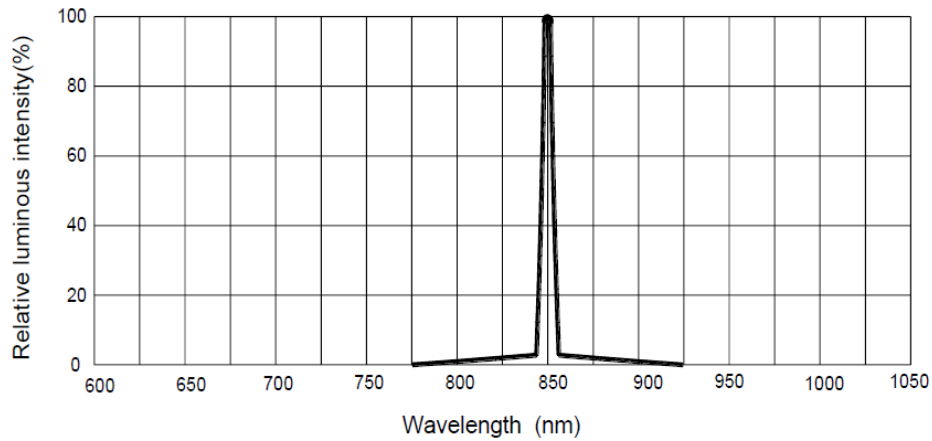
Bin Code	Min.	Max.	Unit
V1	1.8	2.2	V
V2	2.2	2.6	
V3	2.6	2.8	

***Notes:**

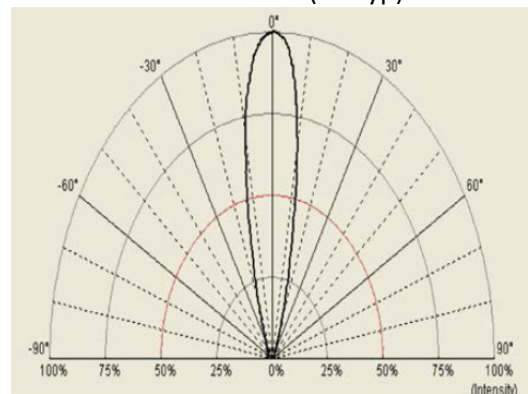
1. Radiometric Power (P_o) $\pm 10\%$.
2. Wavelength (λ_p) $\pm 2.0\text{nm}$
3. Forward voltage (V_F) $\pm 0.12\text{V}$

Electronic-Optical Characteristics

Spectrum Distribution



Beam Pattern (25°typ)



***Notes:**

Viewing angle (2θ1/2) ± 10°

Ordering Information

Orderable Part Number	Peak Wavelength (nm)	Radiometric Power (mW) @1200mA		Forward Voltage (V) @1200mA		Viewing Angle
		Min	Max	Min	Max	
INV-K1TOIR	840-860	700	1100	1.8	2.8	30°

Label Specifications

 Inolux			Date: yyyy/mm/dd
CUSTOMER P/N: 			
INOLUX P/N: 			QTY: PCS
LOT NO: 			QC
IV BIN:	COLOR BIN:	VF:	

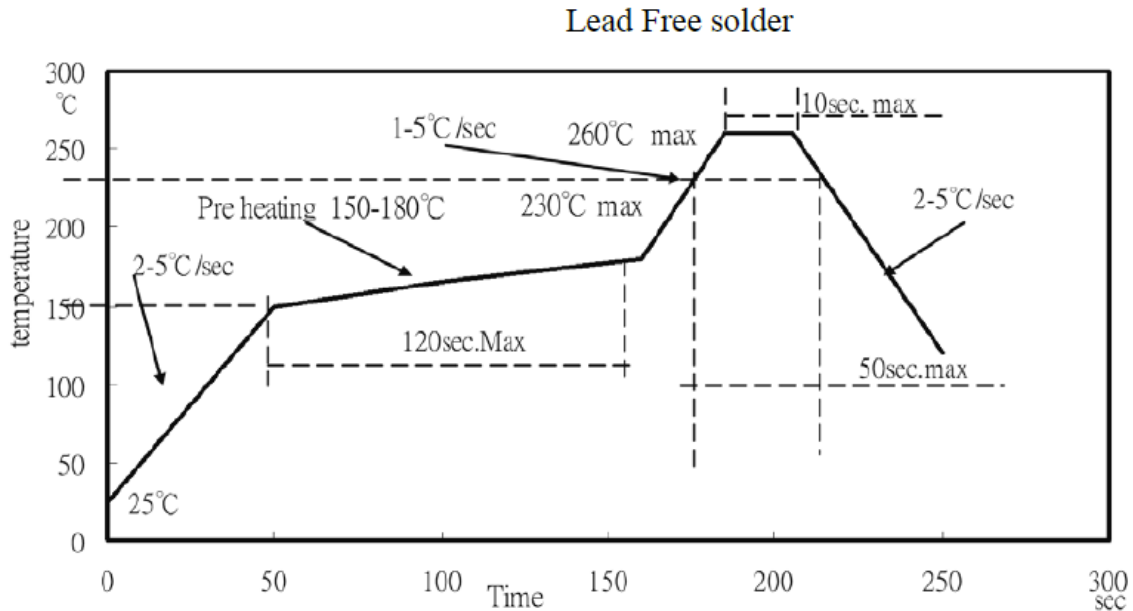
Inolux P/N:

INV	-	K1	T	O		IR	-	X	X	X	X
Inolux VCSEL		Package	Orientation	Current	Lens	Color		Customized Stamp-off			
		K1 Package	T = Top Mount	O = 1200mA	(Blank) = Clear	IR = 850nm					

Lot No.:

Z	2	0	1	7	01	24	001
Internal Tracker	Year (2017, 2018,)				Month	Date	Serial

Reflow Soldering



Soldering Iron

Basic Spec is ≤ 4 sec. when 260°C (+10°C → -1 second). Power dissipation of Iron should be less than 15W. Surface temperature should be under 230°C

Rework

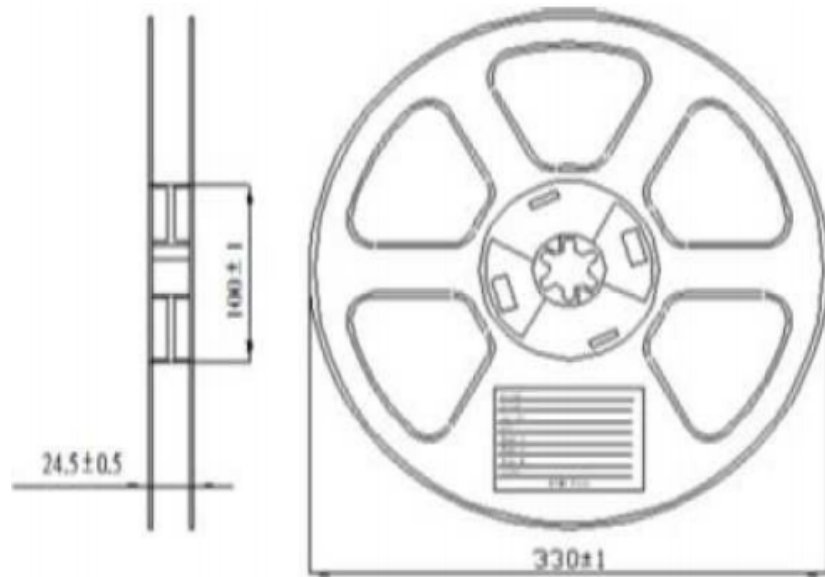
Rework should be completed within 4 second under 245°C

Notes

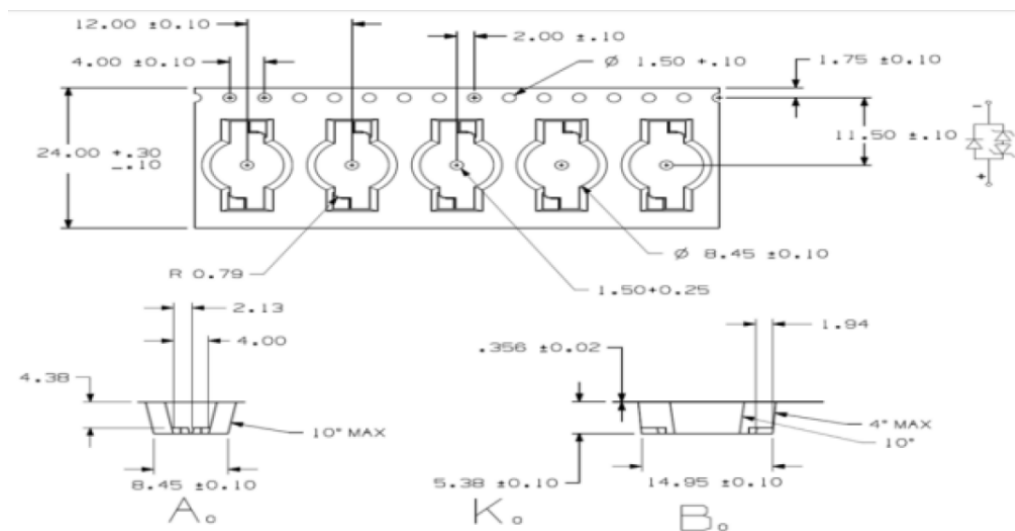
1. Do not stress the silicone resin while it is exposed to high temperature.
2. The number of reflow process should not exceed 3 times.

Packing

Dimension of Reel (Unit: mm)



Dimension of Tape (Unit: mm)



Notes:

1. Empty component pockets are sealed with top cover tape;
2. The maximum number of missing SMDs is two;
3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications;
4. 500pcs/Reel

Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	05-14-2019

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.